




Features

- > Memory chips are carefully screened through a strict filtering process
- > High-quality PCB (Printed Circuit Board)
- > Aluminum heat sink effectively lowers module temperature

Specifications

- > Densities 4GB–16GB (with 4GB and 8GB kits)
- > Frequency speed DDR3: 1600MHz–2133MHz
- > Operating temperature 0°C to 85°C
- > Storage temperature -55°C to 100°C
- > Dimensions 133 X 32 X 7mm
- > Available in a variety of CAS latencies
- > Compatibility tested with all popular brands of motherboards
- > 100% tested
- > Limited lifetime warranty

Ordering Information

Part Number	Capacity	CL	Voltage	Packaging	Image
AX3U1600W4G11-DRH	4GB x 2	CL 11-11-11-28	1.5V	DUAL RETAIL	
AX3U1600W8G11-DRH	8GB x 2	CL 11-11-11-28	1.5V	DUAL RETAIL	
AX3U1600GC4G9-BG	4GB x 1	CL 9-9-9-24	1.5V	BULK	
AX3U1600GC4G9-1G	4GB x 1	CL 9-9-9-24	1.5V	RETAIL	
AX3U1600GC4G9-2G	4GB x 2	CL 9-9-9-24	1.5V	DUAL RETAIL	
AX3U1600GW8G9-BG	8GB x 1	CL 9-9-9-24	1.5V	BULK	
AX3U1600GW8G9-1G	8GB x 1	CL 9-9-9-24	1.5V	RETAIL	
AX3U1600GW8G9-2G	8GB x 2	CL 9-9-9-24	1.5V	DUAL RETAIL	
AXDU1600GW8G9B-1G	8GB x 1	CL 9-11-9-27	1.35V	RETAIL	
AXDU1600GW8G9B-2G	8GB x 2	CL 9-11-9-27	1.35V	DUAL RETAIL	
AX3U1866XC4G10-2X	4GB x 2	CL 10-11-10-30	1.5V	DUAL RETAIL	
AX3U1866XW4G10-2X	4GB x 2	CL 10-11-10-30	1.5V	DUAL RETAIL	
AX3U1866XW8G10-2X	8GB x 2	CL 10-11-10-30	1.5V	DUAL RETAIL	
AX3U2133XC4G10-2X	4GB x 2	CL 10-11-11-30	1.65V	DUAL RETAIL	
AX3U2133XW4G10-2X	4GB x 2	CL 10-11-11-30	1.65V	DUAL RETAIL	
AX3U2133XW8G10-2X	8GB x 2	CL 10-11-11-30	1.65V	DUAL RETAIL	

Packaging Information

Type	Weight	Dimensions	PCs/Carton	CUFT	Carton Gross Weight	Carton Dimensions
Bulk	25g	NA	200 pcs	1.2	11.25kg	420 x 330 x 260mm
Retail	72g	133.5 x 165 x 19mm	100 pcs	1.11	8.2kg	606 x 345 x 150mm
Dual Retail	119g	168 x 164 x 19mm	80 kit	1.59	10.6kg	553 x 417 x 195mm

